







PRODUCT NUMBER	SOLDER BALL COMPOSITION	CONTACT PLATING PERFORMANCE LEVEL					
10082973-001	STANDARD (EUTECTIC)	PERFORMANCE-BASED PLATING,QUALIFIED TO MEET THE REQUIREMENTS OF FCI PRODUCT SPECIFICATION GS-12-192,INCLUDING TELCORDIA CENTRAL OFFICE					
10082973-001LF	LEADFREE						

NOTES:

(I) MATERIAL:
HOUSING: LCP
CONTACT: COPPER ALLOY
PLATING (CONTACT): Au OVER Ni.
UL RATING: 94 V-O
SOLDERBALL: (SEE TABLE) EUTECTIC
SnPb OR LEAD FREE 95.5 Sn/4Ag/0.5Cu.

- 2) SOLDER BALLS WILL NOT BE PERFECT SHPERICAL SHAPE DUE TO REFLOW ATTACHMENT.
- 3) MATED HEIGHT EFFECTED BY CUSTOMERS' PCB PAD SIZE, PLATING, SOLDER REFLOW PROFILE & SOLDER PASTE.
- 4. CONTACTS IN ROWS A,C,E,G,J,K,M,P,R AND T)
 ARE SINGLE BEAM CONTACTS,
 USED AS GROUND PINS.
 (NOTE: CONTACTS IN ROWS J & K ARE
 TIED TOGETHER [COMMONED])
- (5) CONTACTS IN ROWS B,D,F,H,L,N,Q AND S ARE DUAL BEAM CONTACTS, TYPICALLY USED AS SIGNAL PINS.
- (6.) SPECIFIED POSITIONAL TOLERANCE DEFINES PAD TO PAD LOCATION WITHIN LAND PATTERN. POSITIONAL TOLERANCE OF LAND PATTERN TO FUDICIAL MARKS OR PCB DATUMS SHALL BE DEFINED BY CUSTOMER. FOR RECOMMENDED PRODUCT APPLICATION AND PCB DESIGN DETAILS, SEE DOC. NO. GS-20-016.

- FOR PROPER APPLICATION FOLLOW FCI APPLICATION SPECIFICATION GS-20-033. LEAD FREE SOLDER BALLS WILL NOT SOLDER PROPERLY IN A LEADED SOLDER PROCESS DUE TO A HIGHER REFLOW TEMPERATURE. LEADFREE PRODUCT IS THEREFORE NOT BACKWARDS COMPATIBLE WITH LEADED OR SOME SOLDERING APPLICATIONS. REFERENCE FCI APPLICATION SPECIFICATION.
- THIS PRODUCT MEETS THE EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-22-008. PRODUCT MEETING THIS DIRECTIVE IS INDENTIFIED IN THE CODE NUMBER MARKED ON EACH PART BY HAVING AN "X" IN THE SEVENTH CHARACTER POSTION.

spec ref	-			dr	Louis Ng		2010/11/01	proje	ection		mm	s i z e	s c	a l e
tolerance std	TO 1 5 DANIO 5 O DANI 5 O O			eng	g Nickor Zuo		2011/05/30			mm		A 4 11:		: 10
ASME YI4.5	TOLERANCES UNLESS OTHERWISE SPECIFIED		chr	Alex Cao		2011/06/24		₩ ¬ -		—	ecn no	EL	X-DG-003943-1	
-			appr	Pei-Ming Zheng		2011/06/27	product	product family		GIG-Array	rel level		Released	
surface /	linear	0.X	±0.30	CC:	Φ C I	G-Array (SELE)		$^{\circ}$ T $^{\circ}$ D $^{\circ}$ D		0 U			rev	
		0.XX	±0.10	T'		= GIG-Array (SELE		CI LUADI	101	0	100829	73		
		0.XXX	±0.05			+ 15m	nm RECP. ASS	Υ			N P			В
=	angular	0°	±2°	www.	fci.com	cat. no).		Pr	oduct	- Custome	r Drw	sheet 5	of 5

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